



Low Capacitance TVS Diode Array

This diode array is configured to protect up to two high speed data transmission lines, used in Low Voltage Differential Signal(LVDS) ports. Acting as a line terminator, minimizes overshoot and undershoot conditions due to bus impedance, as well as protect against over-voltage events as electrostatic discharges. The line-line concept minimizes the problems to customers to re-route PCB lines, simplifying the design.

FEATURES

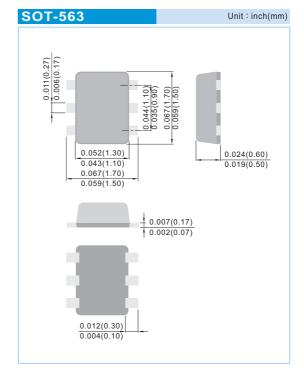
- · Maximum Capacitance of 1.2pF at 0Vdc 1MHz Line-to-Ground
- Maximum Leakage Current of 1.0uA @ VRWM
- Industry Standard SMT Package SOT-563
- IEC61000-4-2 Full Compliance; 15kV air,8kV Contact
- 100% Tin Matte finish(LEAD-FREE PRODUCT)
- · Lead free in comply with EU RoHS 2002/95/EC directives.
- Green molding compound as per IEC61249 Std. . (Halogen Free)

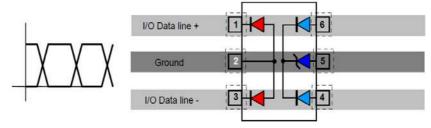
MECHANICAL DATA

- · Case: SOT-563, Plastic
- Terminals:Solder plated,solderable per MIL-STD-750,Method2026
- · Appox Weight: 0.0026 grams, 0.00009 ounces

APPLICATIONS

- · USB 2.0 and Firewire Port Protection
- HDMI Version 1.3
- DVI
- Marking:05





Line-line concept ease the PCB design, directly placing the device over the data lines, opening only the contact points.

VREF is fixed by the operating voltage, referenced to the ground.

Note: pins 1 and 6 (Line1), pins 3 and 4 (Line2) and pins 2 and 5 (Gnd) must be connected externally, as the drawing attached below.

MAXIMUM RATINGS (TJ=25°C unless otherwise noted)

RATING	SYMBOL	VALUE	UNITS
Peak Pulse Power (8/20μs Waveform)	Ppp	75	W
Peak Pulse Current (8/20μs Waveform)	I PP	5	Α
Operating Temperature Range	TJ	-55 to 125	°C
Storage Temperature Range	Тѕтс	-55 to 150	°C
Soldering Temperature, t max=10s	T∟	260	°C





ELECTRICAL CHARACTERISTICS (TJ=25°C unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Reverse Stand-Off Voltage	VRWM	-	-	-	5	V
Reverse Breakdown Voltage	VBR	I BR=1mA	6.2	-	-	V
Reverse Leakage Current	l R	V _R =5V	-	-	1.0	μА
Clamping Voltage (8/20µs)	Vc	I pp=1A	-	-	10	V
Clamping Voltage (8/20µs)	Vc	I pp=2A	-	-	12	V
Clamping Voltage (8/20μs)	Vc	I pp=5A	-	-	15	V
Off State Junction Capacitance	0.	0 Vdc Bias f=1MHz Between I/O pins and pin GND	-	-	1.2	pF
	C1	0 Vdc Bias f=1MHz Between I/O pins	-	-	0.6	pF

ELECTRICAL CHARACTERISTIC CURVES

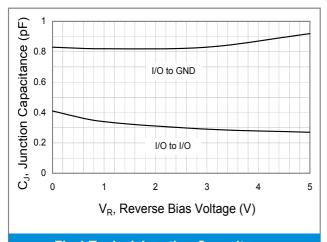


Fig.1 Typical Junction Capacitance

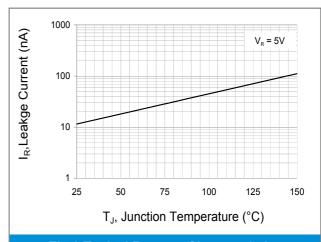


Fig.2 Typical Reverse Characteristics

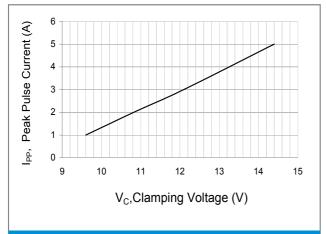


Fig.3 Typical Peak Clamping Voltage (8/20µs)

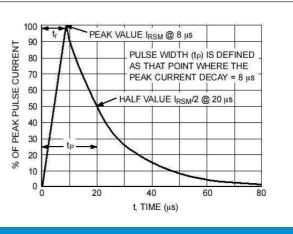
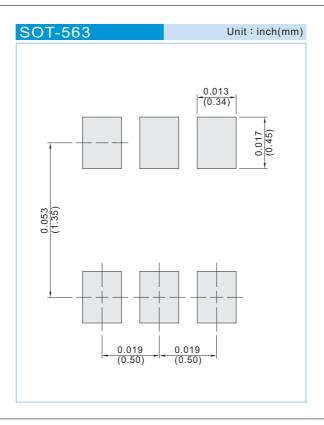


Fig.4 8/20µs Peak Pulse Current Waveform





MOUNTING PAD LAYOUT



ORDER INFORMATION

· Packing information

T/R - 4K per 7" plastic Reel

T/R - 10K per 13" plastic Reel

LEGAL STATEMENT

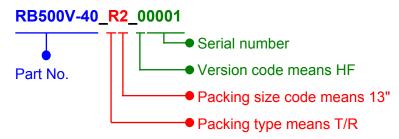
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For example:



Part No_packing code_Version

PJDLLLC05_R1_00001 PJDLLLC05_R1_10001 PJDLLLC05_R2_00001 PJDLLLC05_R2_10001

Packing Code XX			Version Code XXXXX			
Packing type	1 st Code	Packing size code	2 nd Code	HF or RoHS	1 st Code	2 nd ~5 th Code
T/B	A	N/A	0	HF	0	serial number
T/R	R	7"	1	RoHS	1	serial number
B/P	В	13"	2			
T/P	T	26mm	X			
TRR	S	52mm	Y			
TRL	L	PBCU	U			
FORMING	F	PBCD	D			